

01-22-2004
1.02651333

To the Honorable Commissioner of Patents and Trademarks: Please receive attached original documents or copy thereof.

1. Name of conveying party(ies):

Kim Sung Jin

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: 01/08/2004

2. Name and address of receiving party(ies)

Name: DADA Corporation

Internal Address: 790-4 Yeoksam-dong, Kangnam-Ku
DADA Center Bldg., Seoul, Republic of Korea

Street Address: _____

City: Seoul State: _____ Zip: 135-080

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Do Hyun Park

Internal Address: _____

200 old Palisade road. Apt. #2H Fort Lee

New Jersey, USA

Street Address: _____

City: New Jersey State: New Jersey Zip: 07024

6. Total number of applications and patents involved: ☐ 1

7. Total fee (37 CFR 3.41).....\$ 40.00

- ☒ Enclosed
☐ Authorized to be charged to deposit account

8. Deposit account number:

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Kim Sung Jin

Name of Person Signing

Signature

January 8, 2004

Date

Total number of pages including cover sheet, attachments, and documents: ☐ 2

Mail documents to be recorded with required cover sheet information to:
 Commissioner of Patents & Trademarks, Box Assignments
 Washington, D.C. 20231

29/197295

011404

ASSIGNMENT OF APPLICATION

Docket Number (Optional)

Whereas, I/We, Kim sung jin of 101-311 sung-won Apt. 360 shinsa-dong, enpyong-gu, Seoul, Korea, hereafter referred to as applicant, have invented certain new and useful improvements in _____

☐ for which an application for a United States Patent was filed on _____

Application Number _____.

☐ for which an application for a United States Patent was executer on _____, and

Whereas, DADA Corporation of Republic of Korea here referred to "assignee" whose mailing address is 790-4 Yeoksam-dong, DADA center Bldg., Kangnam-Ku, Seoul, Republic of Korea is

desirous of acquiring the entire right, title and interest in the same;

Now, therefore, in consideration of the sum of one dollars (\$ 1.00), the receipt whereof is acknowledge, and other good and valuable consideration, I/We, the applicant(s), by these presents do sell, assign and transfer unto said assignee the full and exclusive right to the said invention in the United States and the entire rights, title and interest in and to any and all Patents which may be granted therefore in the United States. I/We hereby authorize and request the Director of the U.S. Patent and Trademark Office to issue said United States Patent to said assignee, of the entire right, title, and interest in and to the same, for his sole use and behoof; and for the use and behoof of his legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by me had this assignment and sale not been made.

Executed this 8 day of January, 20 04.

at the office of DADA corp.


Signature

State of _____)

SS:

Printed Name/Registration No., if applicable

County of _____)

Before me personally appeared said _____

and acknowledged the foregoing instrument to be his free act and deed this _____

day of _____, 20 _____.

Seal

Note: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, See below".

☐ Total of _____ forms are submitted.

This form offers a sample or suggested format for an assignment document. This sample form is not an OMB officially approved form.